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**General Information**

Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

**Dimensions**

L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
T	1.6mm +/-0.20mm
S	2.3mm MIN
B	0.6mm +/-0.35mm
Case Code (EIA / mm)	1812 / 4532

**Packaging Specifications**

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

**Specifications**

Capacitance	0.22 uF
Measurement Condition	1kHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	4.5455 GOhms

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